IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Gabric, et al.

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For:

Plasma Excited Chemical Vapor Deposition Method,

Silicon/Oxygen/Nitrogen-Containing-Material and Layered Assembly

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Transmittal of English Translation of Specification

Dear Sir:

Attached is an English translation of the above-identified specification, which was filed in German as PCT/DE2005/000088. I hereby attest that this translation is a true and accurate translation of the PCT application as published.

Date

Respectfully submitted,

Reg. No. 35,272

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